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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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EXAMINER

DESTA, ELIAS

ART UNIT PAPER NUMBER

2857

DATE MAILED: 12/19/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Detailed Action

Restriction/Election

1. Applicant's election with traverse, claims 1-34 and 39-55 of Group I in the reply filed on September 8, 2005 is acknowledged. The traversal is on the ground(s) that the search required to examine the entire application would not place a serious burden on the examiner. This is not found persuasive because claims 1-34 and 39-55 of Group I and claims 35-38 of Group II are distinct inventions. The Examiner has shown that the apparatus as claimed (Group II) can be used to practice another and materially different process, such as GUI used in automobile manufacturing plant in controlling robot arms or in food processing plants.

The requirement is still deemed proper and is therefore made FINAL.

Drawing

2. The drawing is objected to because of the following minor informalities:
- Figs. 1-6: boxes should be labeled as to function (similar to Fig. 11 of the instant application).

Claim rejection – 35 U.S.C. § 101

3. 35 U.S.C. 101 reads as follows:

Whoever invents or discovers any new and useful process, machine, manufacture, or composition of matter, or any new and useful improvement thereof, may obtain a patent therefor, subject to the conditions and requirements of this title.

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4. The claimed invention is directed to non-statutory subject matter. Claims 1-55 appear to be nonstatutory and are rejected under 35 U.S.C. § 101 because the claimed subject matter is only measuring and calculating, so it represents an algorithm with a measuring step.

In this instance, transformation of data, representing discrete values, by a machine through a series of mathematical calculations into a final output, does not constitute a practical application of a mathematical algorithm, formula, or calculation, because it does not produce a useful, concrete and tangible result, see *State Street*, 149 F.3d at 1373, 47 USPQ2d at 1601. The claims are directed essentially to a method of calculating a new process control input data where the algorithm lacks the final step of an output, which is useful, concrete and tangible result to make it statutory even though the solution is for a specific purpose.

Claim rejection – 35 U.S.C. § 102

5. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) The invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

6. Claims 1-34 and 39-55 are rejected under 35 U.S.C. 102(e) as anticipated by Pasady et al. (U.S. PAP 2005/0221514, hereon Pasady).

In reference to claims 1, 18, 32 and 39, Pasadyne teaches a method of controlling a process in a semiconductor manufacturing system (see Pasadyne, page 2, paragraph 14, lines 1-9). The method includes:

- Setting process control input data for the process in the semiconductor manufacturing system (see Pasadyne, page 3, paragraph 43, lines 6-15);
- Measuring process control output data from the process in the semiconductor manufacturing system (see Pasadyne, page 4, paragraph 45, lines 6-8);
- Determining a relationship between the process control output data and the process control input data because the system uses a closed-loop, run-to-run model where an input-output relationship is established (see Pasadyne, page 4, paragraph 44, lines 11-13); and
- Calculating new process control input data by minimizing the difference between the target process control output data and predicted process control output data is determined using the relationship applied to the new process control input data (see Pasadyne, page 4, paragraphs 49-51).

With regard to claims 2, 19, 33 and 40, Pasadyne further teaches that updating the relationship between the process control input data and process control output data (see Pasadyne, page 5, paragraphs 53-54)

With regard to claims 3, 20 and 41: *Pasadyn* further teaches that updating the relationship includes using an exponentially weighted moving average (EMWA) filter (see *Pasadyn*, page 9, paragraph 91 and equation 1).

With regard to claims 4, 5, 42 and 43: *Pasadyn* further teaches that calculating the new process input data includes weighing the process control input data prior to calculating new process control input data (see *Pasadyn*, page 9, paragraph 95); and weighing the process control output data prior to calculating new process control input data (see *Pasadyn*, page 9, paragraph 97).

With regard to claims 6 and 44: *Pasadyn* further teaches that the calculating method includes minimizing the difference between the process control input data and the new process control input data (or error function) (see *Pasadyn*, page 4, paragraph 49)

With regard to claims 7, 21 and 45: *Pasadyn* further teaches that determining the process control input and output data includes developing a relationship with a process model developed using partial least square (PLS) analysis (see *Pasadyn*, page 4, paragraph 48, lines 23-25)

With regard to claims 8, 9, 22, 23, 46 and 47: *Pasadyn* further teaches that determining the relationship between the process control output and input data includes developing the relationship with multiple input-multiple output process model (MIMO) because the single model would be modified to accommodate multiple processing contexts (see *Pasadyn*, page 31, paragraph 333); and developing

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as a MIMO process model characterized by an equation with control output data and input data with array of constants with a function as a factor of the input variables (see Pasadyn, page 5, paragraph 54, equation 'Co' representing input/output relationship).

With regard to claims 10, 11, 24, 25, 48 and 49: Pasadyn further teaches that function that describes control output as a function of the input and some other constant represents a non-linear and linear function [see Pasadyn, pages 4-5, paragraph 52 (the premises is that a non-linear function could be approximated or forced to behave like a linear function without loss of generality in obtaining the desired outcome)]

With regard to claims 12, 13, 14, 26- 28, 34, 50, 51 and 52: Pasadyn further teaches that setting the process input data includes an etch process and RF power (see Pasadyn, page 6, paragraph 66).

With regard to claims 15, 29 and 53: Pasadyn further teaches that measuring process control output data includes a deposition rate or time (see Pasadyn, page 6, paragraph 66).

With regard to claims 16, 30 and 54: Pasadyn further teaches that measuring process control output includes modeling a state space representation which inherently includes measuring critical dimensions at the top, bottom, slope and sidewall of the contact of the wafer because it is well known in the art that during wafer manufacturing, the control variables includes dimensional or state-space

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variables that would be measured to make sure manufacturing variables are controlled to obtain desirable output (see Pasady, page 10, paragraphs 110-111, and pages 27-28, paragraphs 289-291).

With regard to claims 17, 31 and 55, Pasady further teaches that minimizing the difference (error function) using an equation (see Pasady, page 4, paragraph 50). The instant claims call for the Newton-Rhapson equation where the equation is used to obtain zeros of multidimensional functions (for instance, see Parmore, 'Simple Curve Fitting', page 1, abstract). The equation is used to relate multiple spectral data fit to a Gaussian function. Since Pasady uses Gaussian model to minimize the noise or error values (see Pasady, page 4, paragraphs 51-52) where the best error fit values are represented as linear function, it is inherent to say that Pasady would use Newton-Rhapson or equivalent equation to obtain zeros of the multidimensional functions.

Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant disclosure.

- Choi et al. (U.S. Patent 5,940,299) teaches system and method for controlling a process-performing apparatus in a semiconductor device manufacturing process.
- Boiquaye (U.S. Patent 6,249,712) teaches adaptive control process and system.

- Stoddard et al. (U.S. Patent 6,589,744) teaches run-to-run controller for use in microelectronic fabrication.
- Hsiung et al. (U.S. Patent 6,853,920) teaches control for an industrial process using one or more multidimensional variable.
- Funk (U.S. PAP 2004/0267399) teaches feed-forward and feedback wafer-to-wafer control methods for etch process.
- Mitrovic (U.S. PAP 2005/0071039) teaches a system and method for using first-principles simulation to provide virtual sensors that facilitate a semiconductor manufacturing process.
- Patel et al. (IEEE Article, 'Adaptive Optimization of Run-to-Run Controllers: The EWMA Example') teaches a recursive scheme for optimizing the gain of an exponentially weighted moving average (EWMA) controller under stability constraints.
- Del Castillo et al. (IEEE Article, 'An Adaptive Run-to-Run Optimizing Controller for Linear and Nonlinear Semiconductor Processes') teaches a run-to-run (R2R) multiple-input-multiple-output controller for semiconductor manufacturing processes')
- Mozumder et al. (IEEE Article, 'A Monitor Wafer Based Controller for Semiconductor Processes') teaches a multivariable adaptation methodology for feedback controller that employs a layered process/equipment model.

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8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Elias Desta whose telephone number is (571)-272-2214. The examiner can normally be reached on M-Thu (8:30-7:00).


If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Marc S. Hoff can be reached on (571)-272-2216. The fax phone numbers for the organization where this application or proceeding is assigned are (571)-273-8300 for regular communications and After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (571)-272-1750.

Elias Desta
Examiner
Art Unit 2857

-ed

November 23, 2005


MARC S. HOFF
SUPERVISORY PATENT EXAMINER
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